

Dawn Coating Summary

S. Penn

Current Research

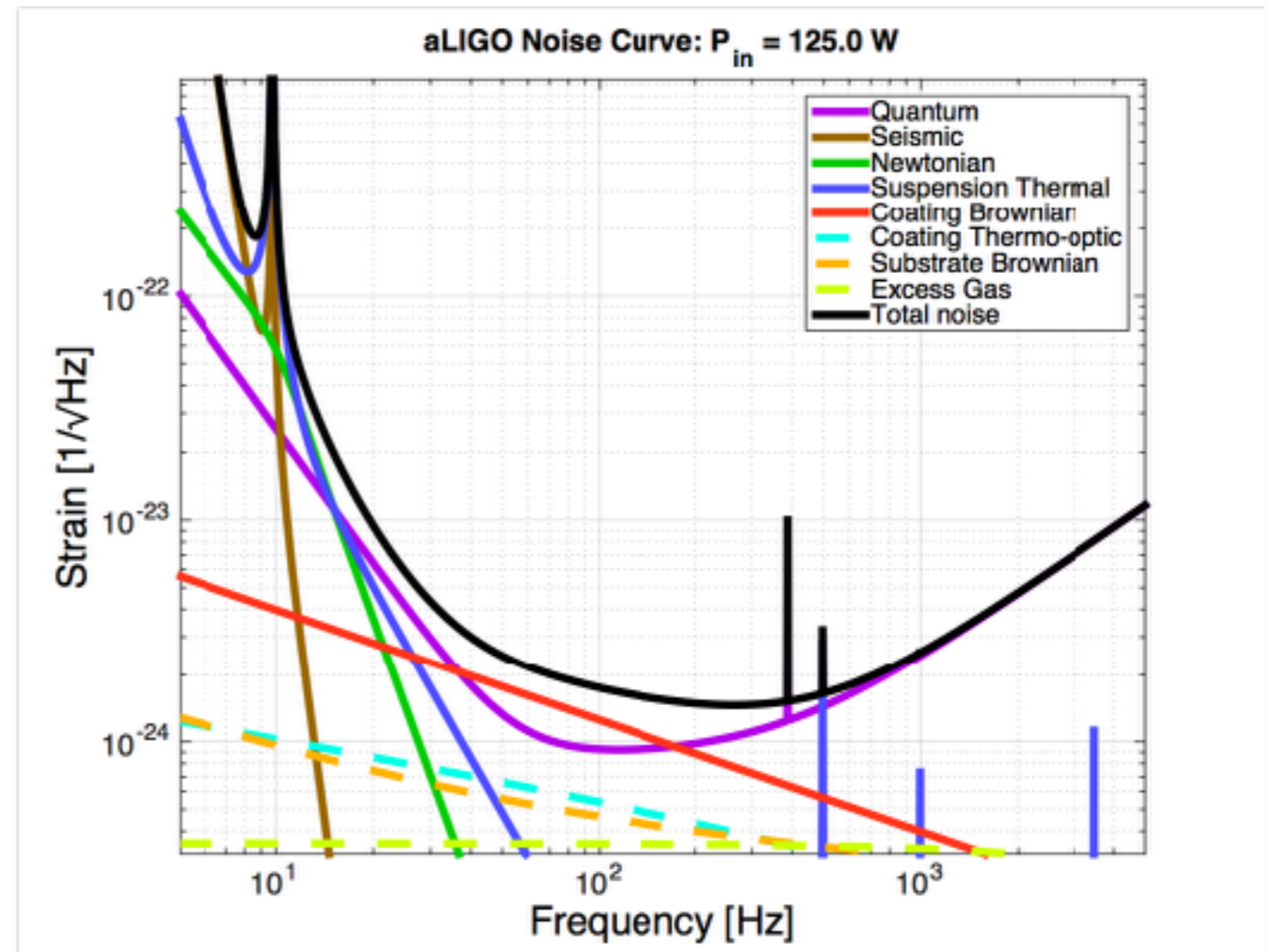
- **Ideal Glass (Heated Substrate, Ion-Beam Assist, IBS)**
 - Rapid Data Acquisition: Multimodal & Nodal Suspension
- **Stabilized, High-T Annealed, Metal-oxide:**
- **Stabilized, Nanolayer Coatings**
- **Crystalline Coatings: AlGaAs & AlGaP**
- **a-Si: (Voyager, 1.5 μm) Ideal Glass**
 - Cryogenic Low loss: 2×10^{-6}
 - Absorption < 20 ppm, (and lowering??)

A+: Advanced LIGO improved

With Advanced LIGO at full power ($P_{in} = 125 \text{ W}$)
Quantum Noise reaches
Coating Thermal Noise

Injecting frequency-dependent squeezed light
lowers Quantum Noise (2018?)

Coating Thermal Noise
reduced by 2x (2020?).
⇒ BNS detection range
to 340 Mpc



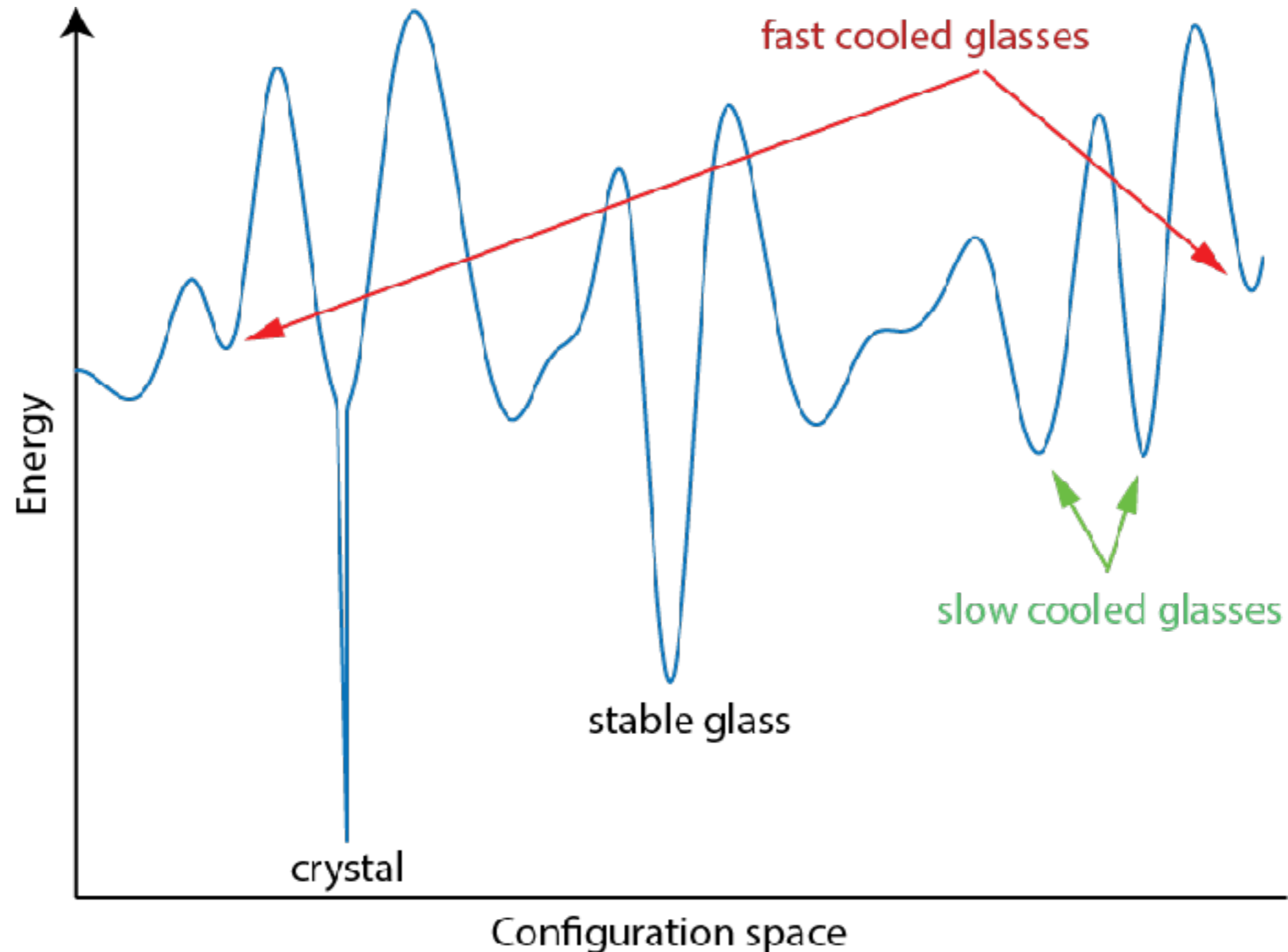
*How do we lower Coating
Thermal Noise by 2x in 3-4 years?*

Center for Coating Research

- **Dawn II Meeting:** Talks & discussion refined ideas for CCR
- **Final Proposal:** 10 institutions, \$4M
- **Research:**
 - Ideal Glass
 - Stabilized coatings
 - Nanolayer coatings
- **Funding???**

Energy Landscape And Stable Glasses

- Potential energy is a function of the position of all particles ($3N$ d.o.f.s!!)
- Going lower means fewer internal dissipations due to two level systems



Increased Mobility Lowers Loss?

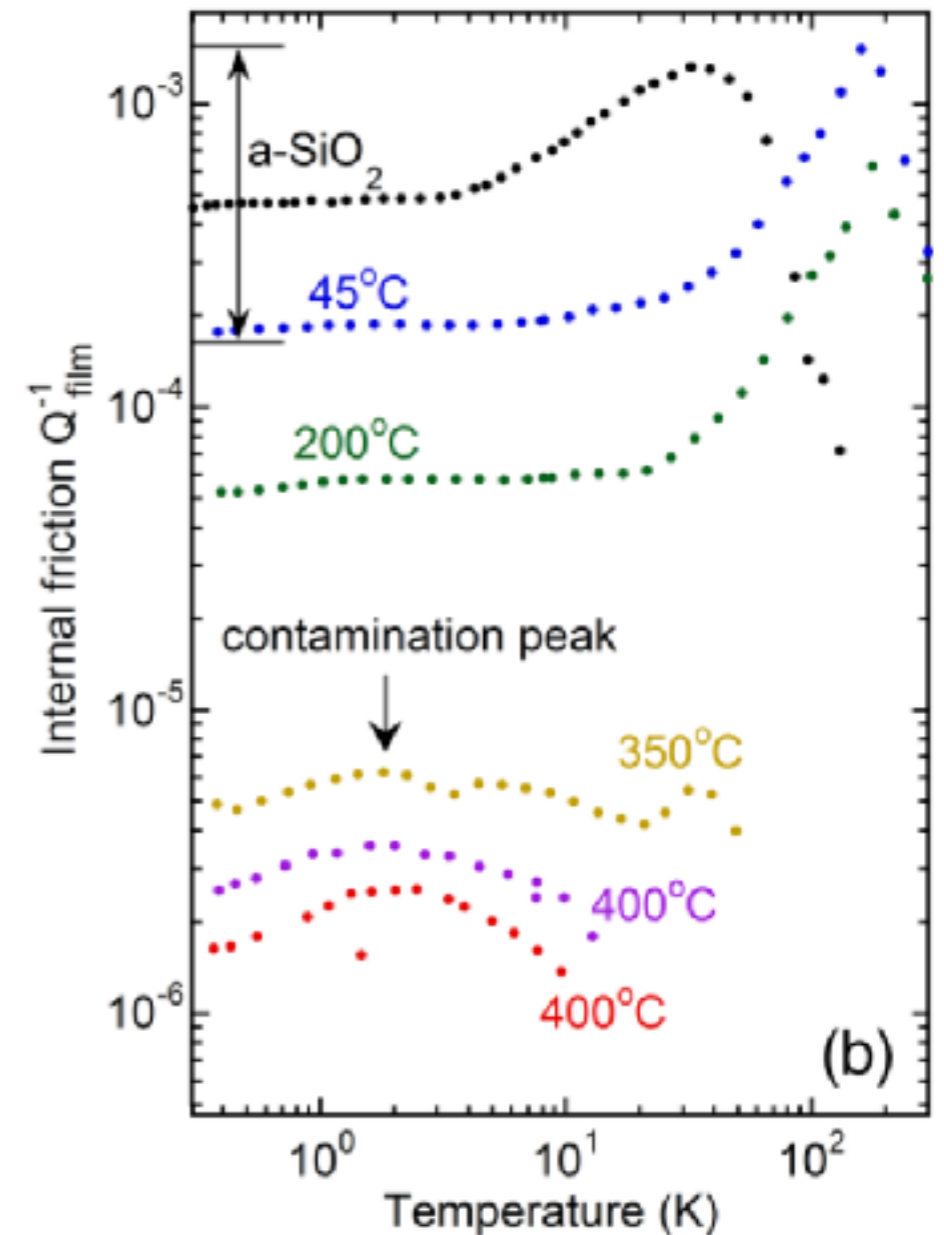
Ultrastable a-Silicon:

- EBD coating on 400 C substrate, $\phi = 2 \times 10^{-6}$ [Liu , et alia, PRL 113, 025503 (2014)].

Ultrastable High-index Metal-oxide Coating:

Goal: allow molecules that are freshly deposited to explore a a larger part of the energy landscape

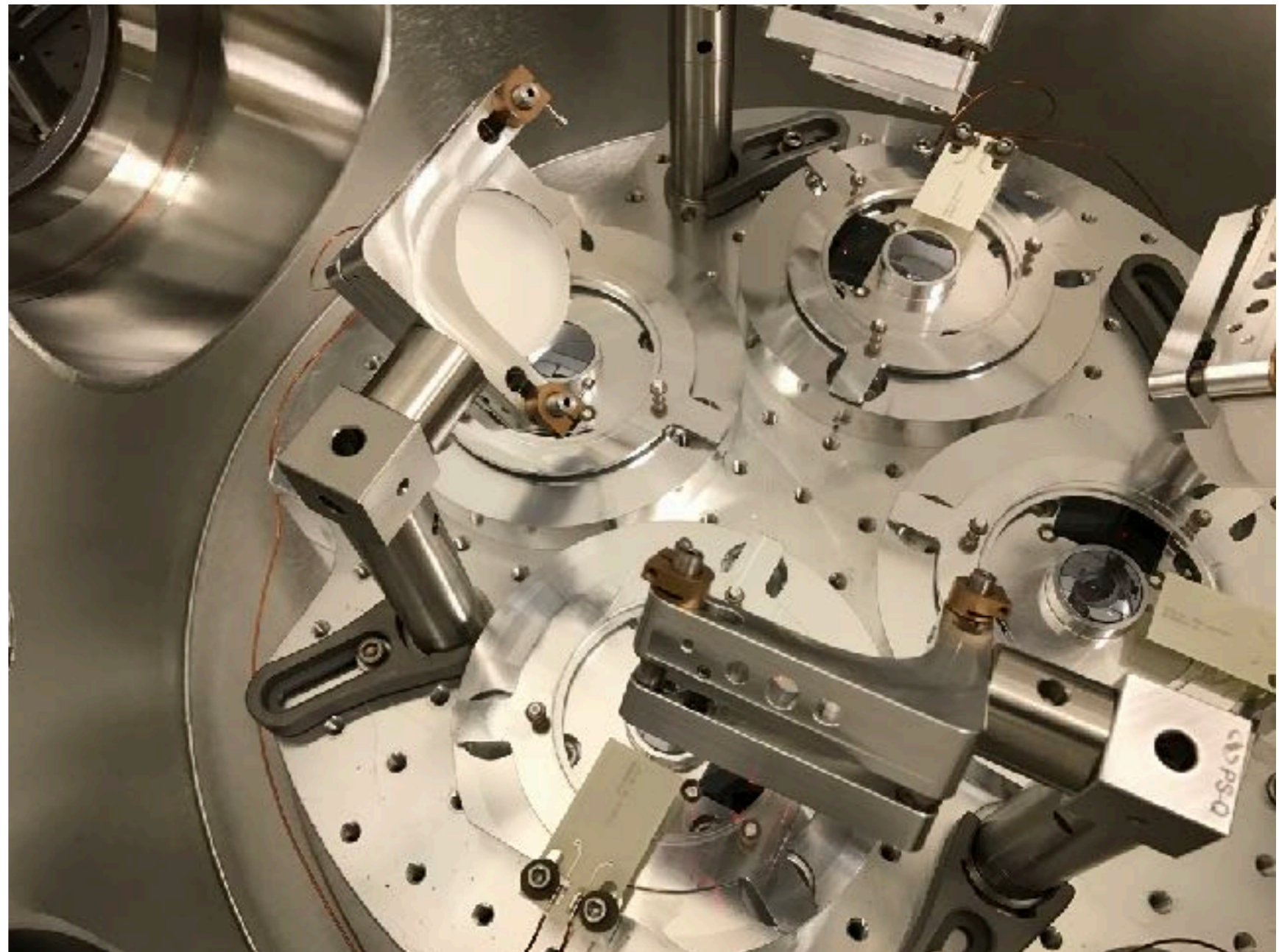
1. **Increase the substrate temperature** to increase the mobility (showed very promising results with a-Si)
2. **Reduce the deposition speed** (giving more time to the newly deposited molecules to move around before a new layer comes in).
3. **Ion beam assisted deposition** (increase the mobility by hitting the molecules already on the surface with an additional ion beam)



Rapid Loss Measurements

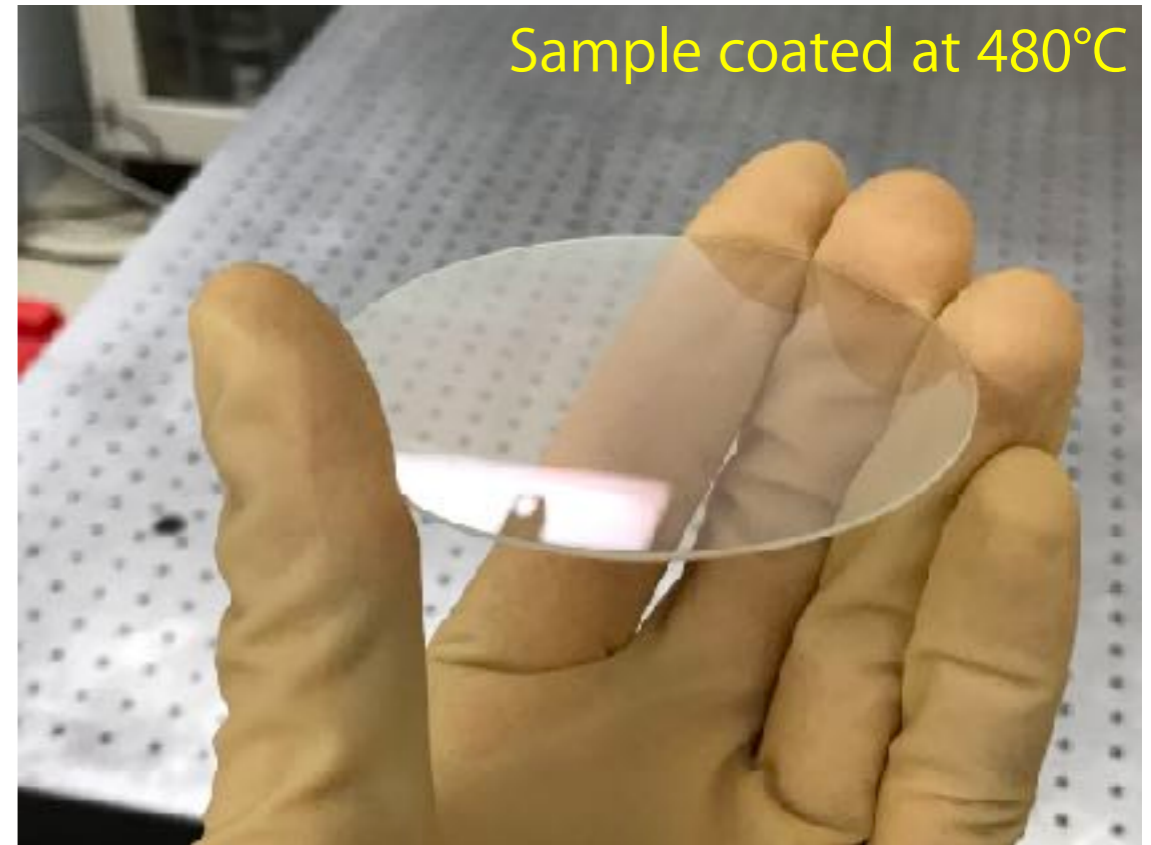
- Measure four samples in parallel in the same chamber
- Digital control system running at a sampling rate of 65 kHz allows us to excite and measure all modes simultaneously

	Time
Install samples and align	15 min.
Pump down	2 hours
Measurement time (depends on Q)	2-5 hours
Venting	30 min.
Total	5-8 hours



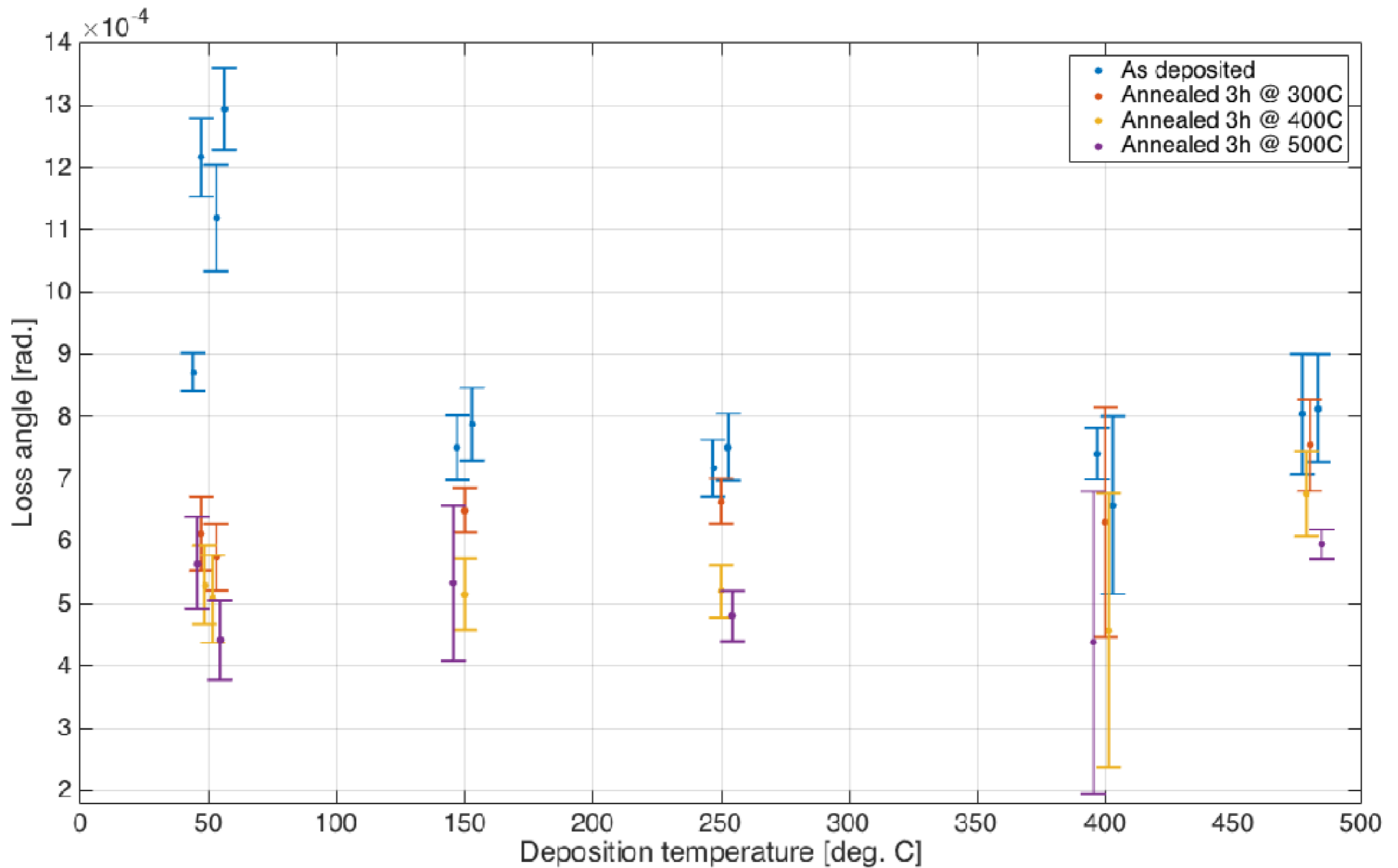
Elevated substrate temperature deposition

- Carried out with magnetron sputtering at Université de Montréal / Polytechnique Montréal
 - Pure tantalum, 1 micron thick layer
- Five temperatures:
 - Room temperature (50°C, 150°C, 250°C, 400°C and 480°C)
 - Sample coated at 480°C looks hazy
- Coating mechanical losses measured at Caltech
 - As deposited, and after annealing (3 hours @ 300°C / 400°C / 500°C)
- Ellipsometry measurements at Montreal
- XRD measurements at HWS and Stanford

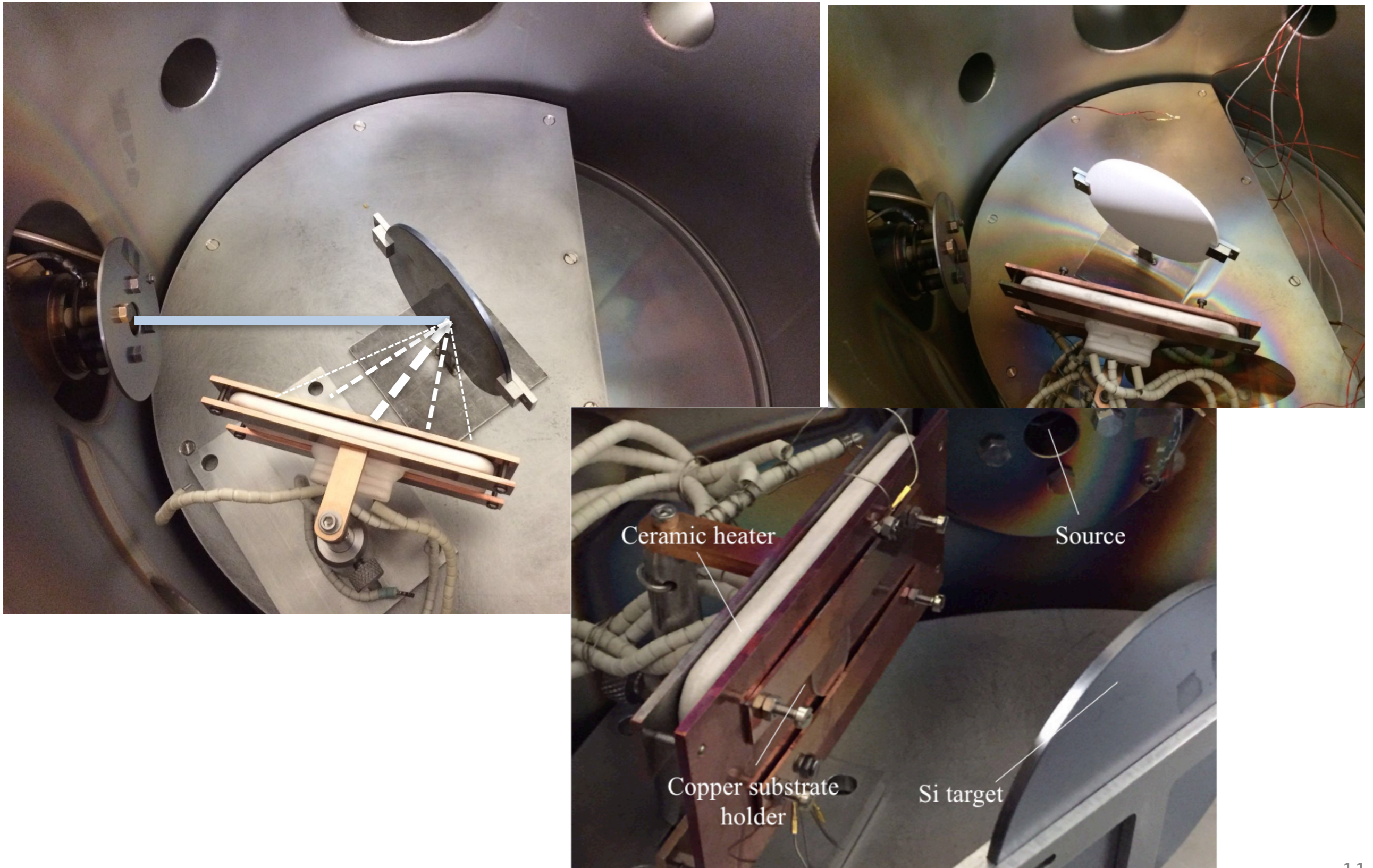


- CMS-18 sputtering system by Kurt J. Lesker
- Base pressure typically 8-9e-8 Torr
- Deposition conditions: 2 mTorr, 450 W on a three-inch Ta target, 60% O₂ vs. Ar, rotation of 20 RPM, pre-sputtered with O₂ for 20 minutes prior to deposition to ensure a stable discharge
- All substrates were pre-cleaned using an O₂/Ar plasma (50% O₂ vs. Ar) for 600 s at 8 mTorr at around -100V.

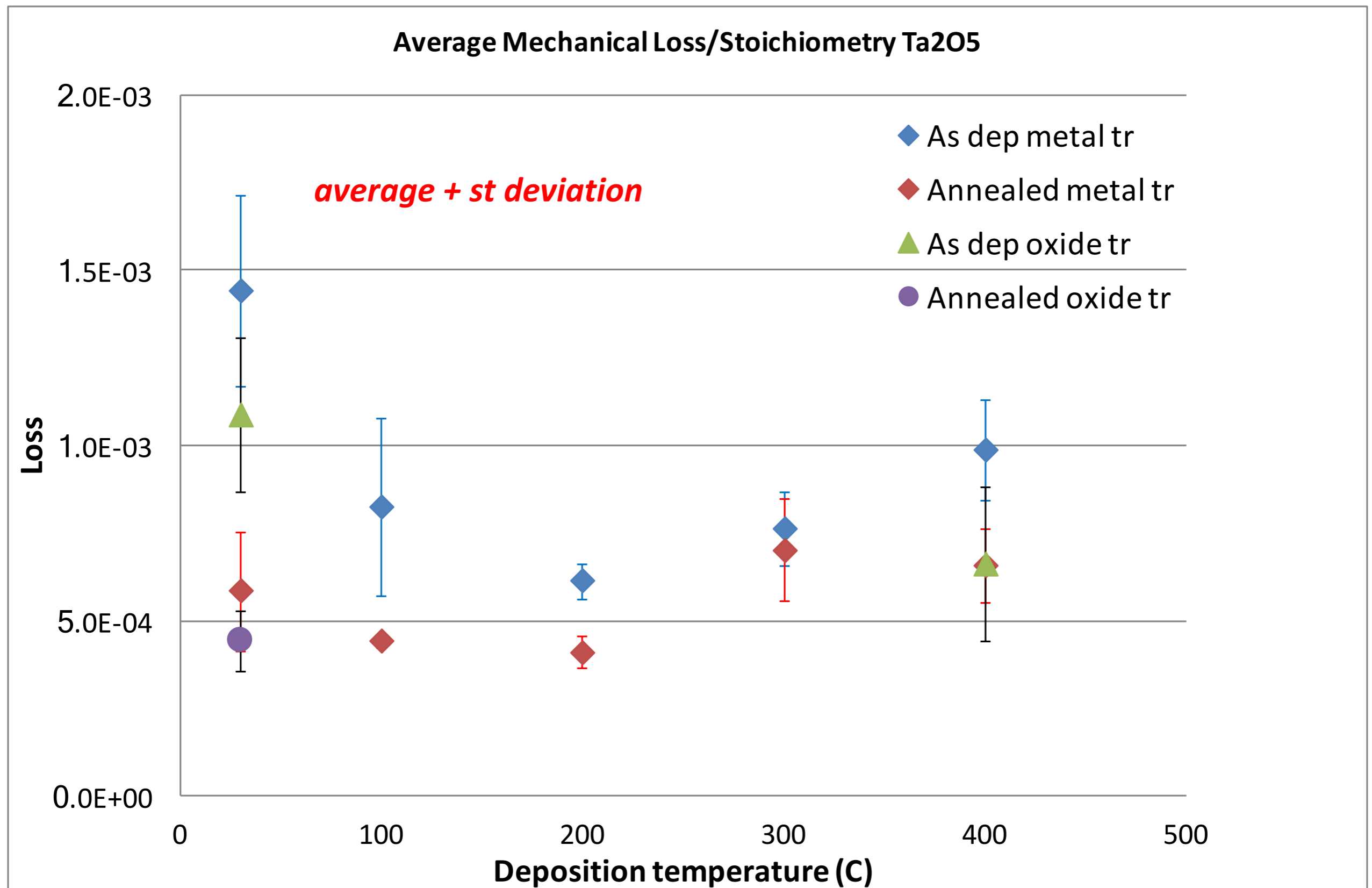
Effect of Annealing



Development of ECR-IBD

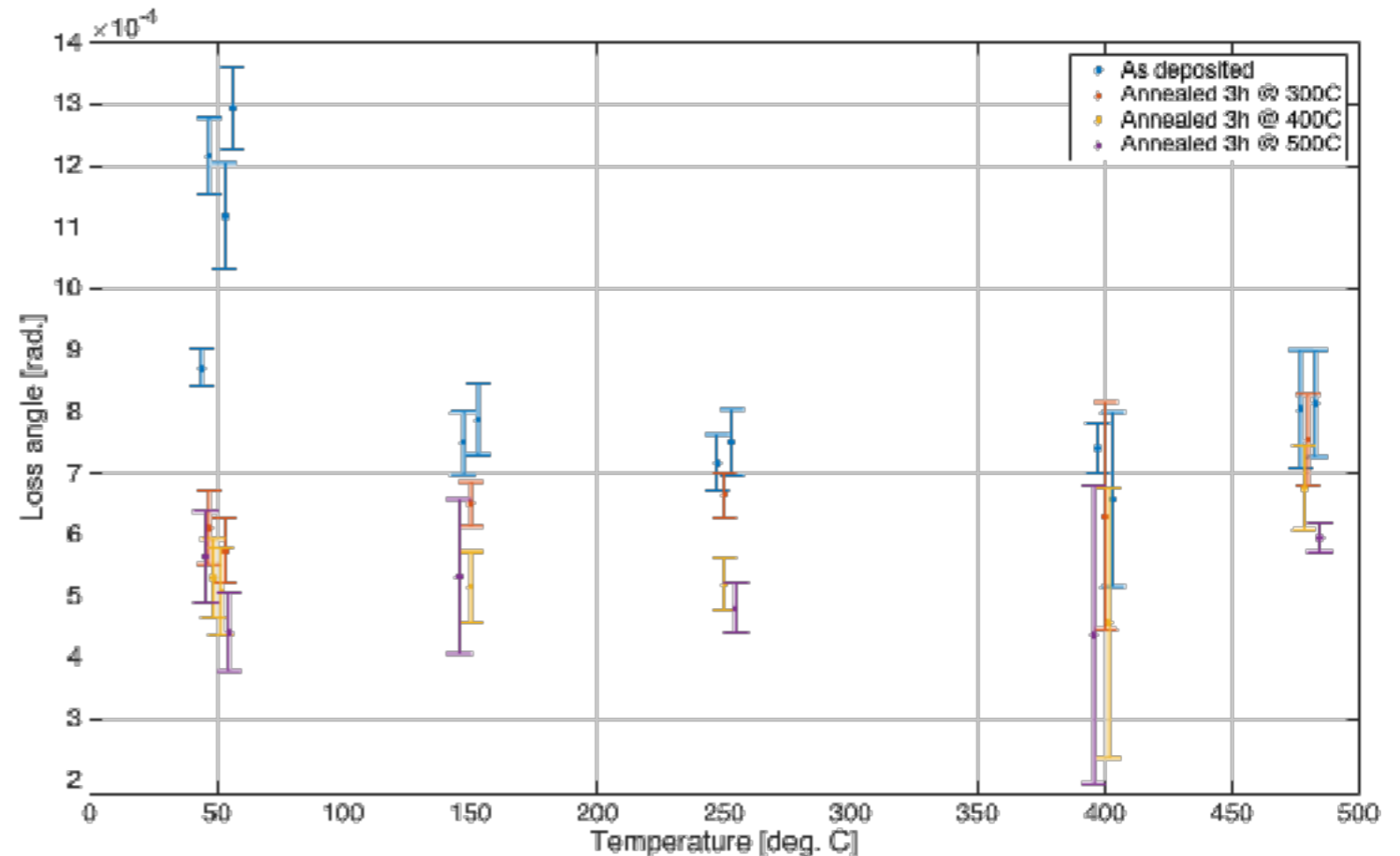


UWS Ta₂O₅ mechanical loss



Heated Substrate Results

- Substrate temperature has an effect on mechanical losses (before annealing)
 - Crystallization at relatively low temperature 480°C, instead of ~600°C observed normally when annealing post deposition
 - Seems to indicate that elevated temperature deposition is somehow more efficient than post deposition annealing
- However, annealing has still a large impact and reduced losses down to a level of 5×10^{-4}
 - Coating deposited at 400 C is also improved a bit



A+: Stabilized, Annealed Amorphous Coatings

Silica-Stabilized Coatings:

- Stabilized coating \implies Higher annealing T \implies Lower Mechanical Loss ϕ
- Added silica lowers index \implies Thicker coatings \implies Higher Mechanical Loss ϕ
- Silica(30%)-Hafnia $T_{\text{anneal}} = 600$ C. $\phi = 3 \times 10^{-4}$ at 14 K
- Silica(20%)-Zirconia $T_{\text{anneal}} = 800$ C. $\phi = 2 \times 10^{-4}$ at 300 K
- No net benefit.

P. Murray: [DCC-G1400275](#)

Mutually-Stabilized Coatings:

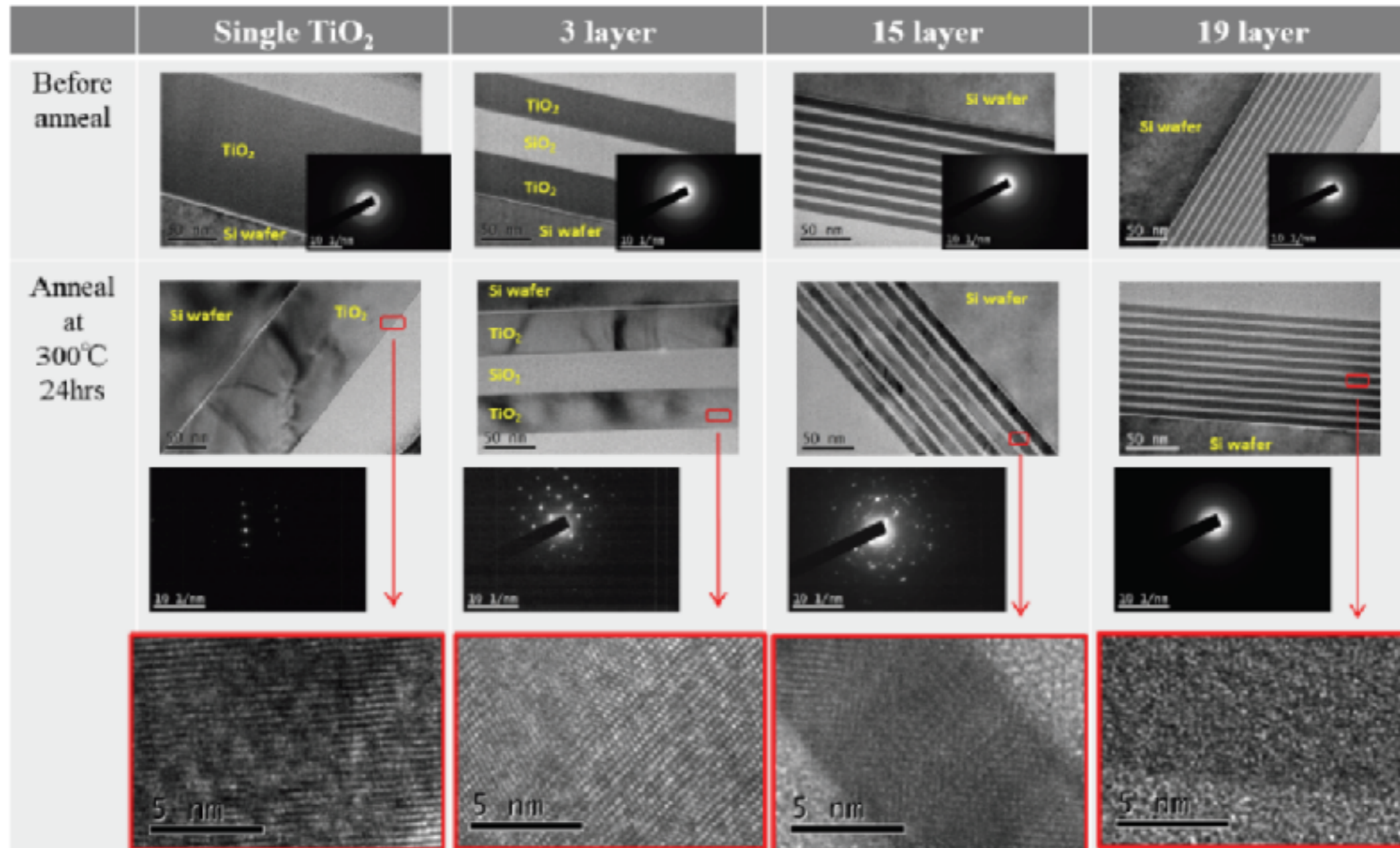
- Stabilized coating \implies Higher annealing T \implies Lower Mechanical Loss ϕ
- Zirconia(34%)-Tantala $T_{\text{anneal}} = 800$ C, $n \approx 2.1-2.2$, $Y = 134$ GPa
- $\phi = 1.4 \times 10^{-4}$ (shear), $\phi = 4 \times 10^{-4}$ (bulk) [Preliminary] Potentially useful. New Run

Nano-Coatings:

- Thinner coatings layers pin the high index material to prevent crystallization
- Stabilized Titania/Silica coatings: 19 sublayers, $T_{\text{anneal}} = 300$ C, $\phi \approx 10^{-4}$
- New Sannio Coating facility to move beyond few nm layer limit to ≤ 1 nm.

Nanolayer coatings: I. Pinto, R. DeSalvo, S. Chao

TEM Before/After Annealing



[S. Chao et al., LIGO-G1300921]

➡ **TEM shows that no significant cross-interface diffusion occurs during annealing**

New University Sannio Coating facility to move beyond few nm layer limit to ≤ 1 nm.

Voyager: AlGaAs Coatings

GaAs/ $\text{Al}_x\text{Ga}_{1-x}\text{As}$ crystal

MBE grown, then transferred

Currently limited to 20 cm diameter

Compatible with 1064–1550 nm

At 1064 nm: Absorption < 1 ppm, Scatter < 3 ppm, T = 10 ppm

At 1530 nm: Absorption $\approx 3.6 \pm 1.3$ ppm [J. Steinlechner, *Class. Quantum Grav.* 32 (2015) 105008]

Mechanical Loss:

Optical cavities: (1 mm beam, 1064 nm) $\phi = 2 \times 10^{-5}$

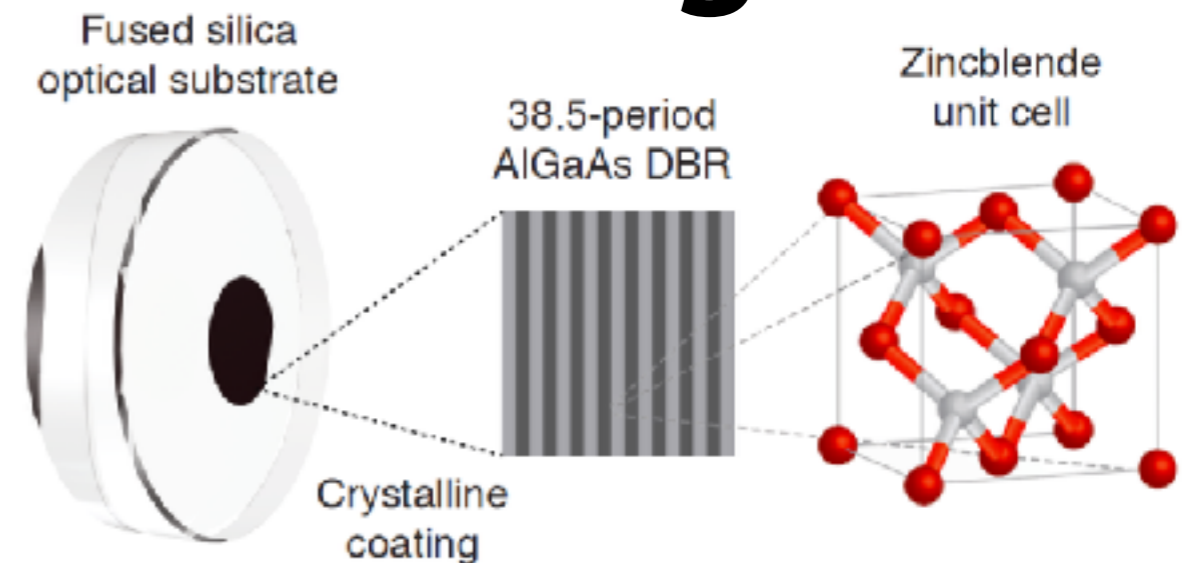
[Cole, et al., *Nature Photonics*, vol. 7, pp. 644–650, Aug. 2013]

Mechanical Ringdown:

Initial Bonding: $\phi = 3 \times 10^{-5}$ (bulk), $\phi = 5 \times 10^{-4}$ interface shear modes)

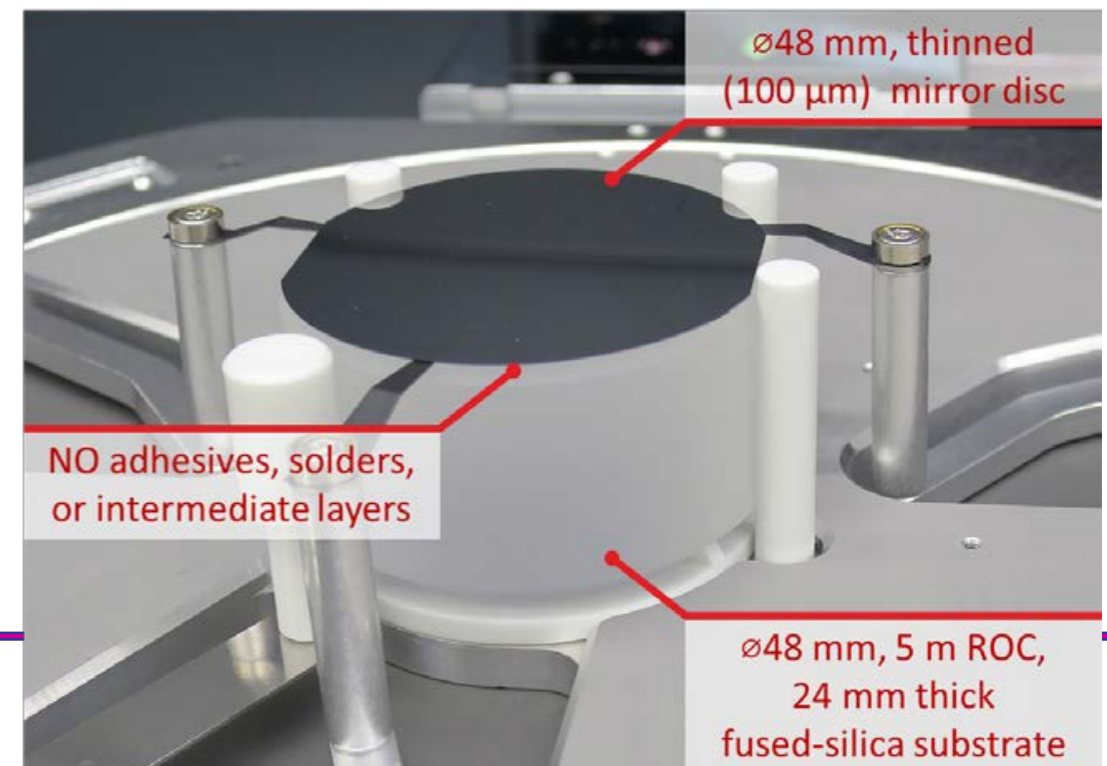
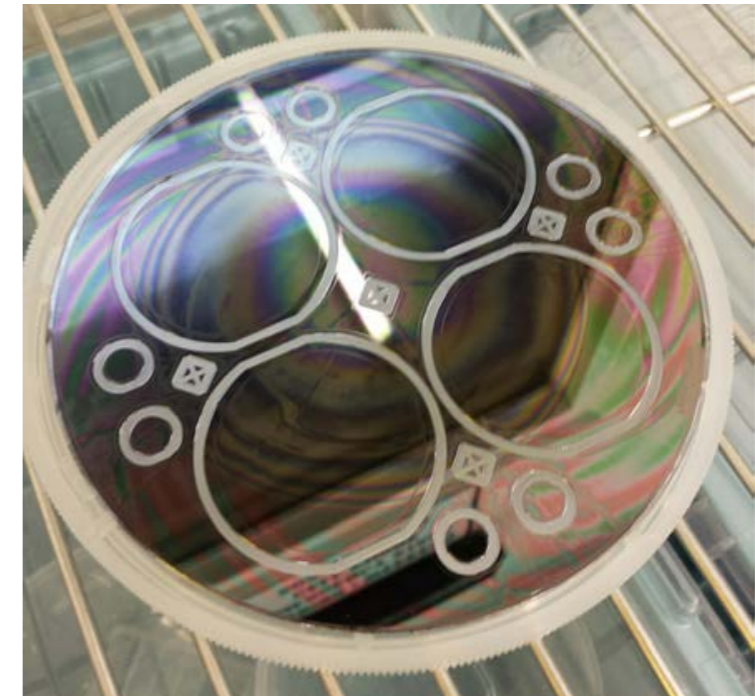
New Bonding: *In progress*

[Penn, et al., <https://dcc.ligo.org/DocDB/0124/G1600660/002/PennCoatingsMarch2016.pdf>]



Credit: G. Cole, et alia, <http://arxiv.org/pdf/1604.00065v1.pdf>

- Epitaxial growth on GaAs wafer
 - ◆ AlGaAs multilayer with varying Al content for index contrast
 - » high index layers consist of binary GaAs thin films
 - » 8% Ga incorporated in low index AlGaAs layers to slow oxidation in ambient
 - ◆ High quality epitaxy requires a lattice matched substrate, same crystalline symmetry, minimal deviation of lattice parameter (atomic spacing)
- Transfer and bonding to the final optical substrate
 - ◆ mirror completely removed from the wafer and bonded to desired substrate



Voyager: AlGaP Coatings

GaP/AlGaP \approx lattice matched to Silicon

Coating grown using MBE on substrate

- Chamber limits size to ≈ 300 mm

No bonding. Low interface losses.

Buffer layer required to adapt lattice

- Adapts lattice spacing, stress change
- Antiphase defects near interface

Cryogenic Loss: $\phi = 1.4 \times 10^{-5}$ at 12 K

High Absorption: 2.3%

- Due to antiphase defects?

